

June 2014

FQA140N10

N-Channel QFET® MOSFET 100 V, 140 A, 10 $m\Omega$

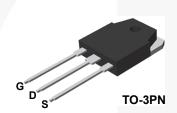
Description

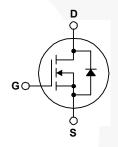
This N-Channel enhancement mode power MOSFET is • 140 A, 100 V, $R_{DS(on)}$ = 10 m Ω (Max.) @ V_{GS} = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state • Low Gate Charge (Typ. 220 nC) resistance, and to provide superior switching performance and Low Crss (Typ. 470 pF) high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor • 100% Avalanche Tested control, and variable switching power applications.

Features

- $I_D = 70 A$

- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter	FQA140N10	Unit	
V_{DSS}	Drain-Source Voltage	100	V	
I _D	Drain Current - Continuous (T _C = 25°C)	140	Α	
	- Continuous (T _C = 100°C)	99	А	
I _{DM}	Drain Current - Pulsed (Note 1)	560	A	
V _{GSS}	Gate-Source Voltage	± 25	V	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	1500	mJ	
I _{AR}	Avalanche Current (Note 1)	140	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)	37.5	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)	6.5	V/ns	
P_{D}	Power Dissipation (T _C = 25°C)	375	W	
	- Derate above 25°C	2.5	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +175	°C	
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds.	300	°C	

Thermal Characteristics

Symbol	Parameter	FQA140N10	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.4	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQA140N10	FQA140N10	TO-3PN	Tube	N/A	N/A	30 units

Electrical Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Uni
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	100			V
ΔBV _{DSS}	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.08		V/°(
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μΑ
	Zero Gate Voltage Drain Current	V _{DS} = 64 V, T _C = 150°C		-	10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 25 V, V _{DS} = 0 V		-	100	nΑ
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -25 V, V _{DS} = 0 V			-100	nΑ
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 70 A		0.008	0.01	Ω
g _{FS}	Forward Transconductance	V _{DS} = 30 V, I _D = 70 A		80		S
	ic Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		6100	7900	pF
C _{oss}	Output Capacitance			2000	2600	pF
C _{rss}	Reverse Transfer Capacitance			420	550	pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time			75	160	ns
t _r	Turn-On Rise Time	$V_{DD} = 40 \text{ V}, I_{D} = 140 \text{ A},$ $R_{G} = 25 \Omega$		940	1890	ns
t _{d(off)}	Turn-Off Delay Time	11G - 23 22		350	710	ns
t _f	Turn-Off Fall Time	(Note 4)		360	730	ns
Qg	Total Gate Charge	V _{DS} = 64 V, I _D = 140 A,		220	285	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		39		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		114		nC
	Source Diode Characteristics at				110	Α.
l _S	Maximum Continuous Drain-Source Diode Forward Current (Note 5)				140	Α

Q_{rr}

t_{rr}

 I_{SM}

 V_{SD}

Drain-Source Diode Forward Voltage

Reverse Recovery Time

Reverse Recovery Charge

- Notes: 1. Repetitive rating : pulse-width limited by maximum junction temperature. 2. L = 0.115 mH, I_{AS} = 140 A, V_{DD} = 25 V, R_G = 25 Ω , starting T_J = 25°C. 3. I_{SD} = 140 A, di/dt \leq 300 A/ μ s, V_{DD} \leq BV_{DSS} starting T_J = 25°C. 4. Essentially independent of operating temperature. 5. Continuous drain current calculated by maximum junction temperature : limited by package.

Maximum Pulsed Drain-Source Diode Forward Current

560

1.5

140

730

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Α

٧

ns

nC

 $V_{GS} = 0 \text{ V}, I_{S} = 140 \text{ A}$

 $V_{GS} = 0 \text{ V, } I_{S} = 140 \text{ A,}$

 $dI_F / dt = 100 A/\mu s$

Typical Characteristics

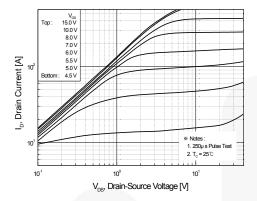


Figure 1. On-Region Characteristics

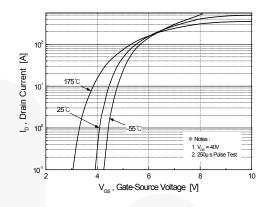


Figure 2. Transfer Characteristics

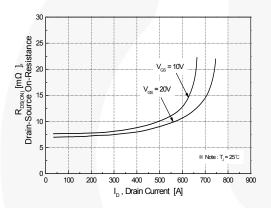


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

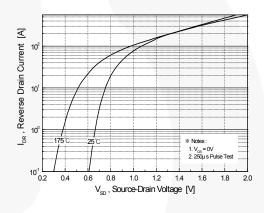


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

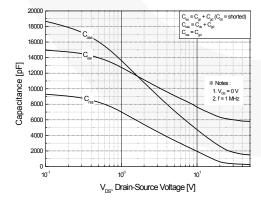


Figure 5. Capacitance Characteristics

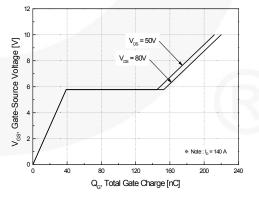


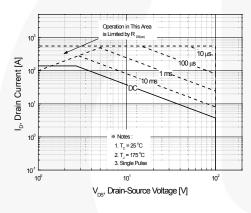
Figure 6. Gate Charge Characteristics

12 (Nomalized) 1.1 (Nomalized

Typical Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



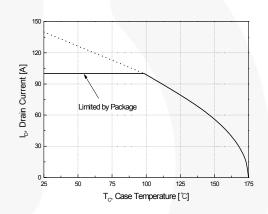


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

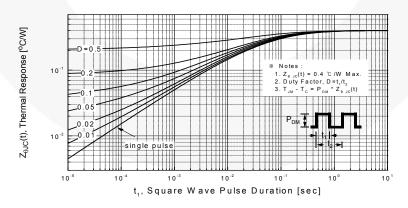


Figure 11. Transient Thermal Response Curve

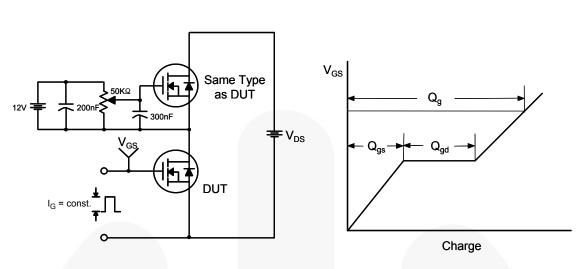


Figure 12. Gate Charge Test Circuit & Waveform

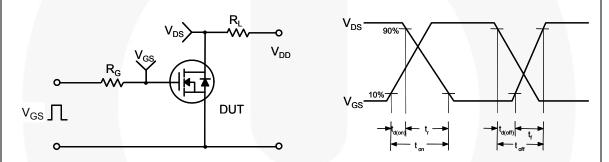


Figure 13. Resistive Switching Test Circuit & Waveforms

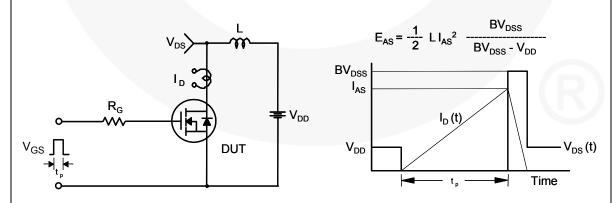
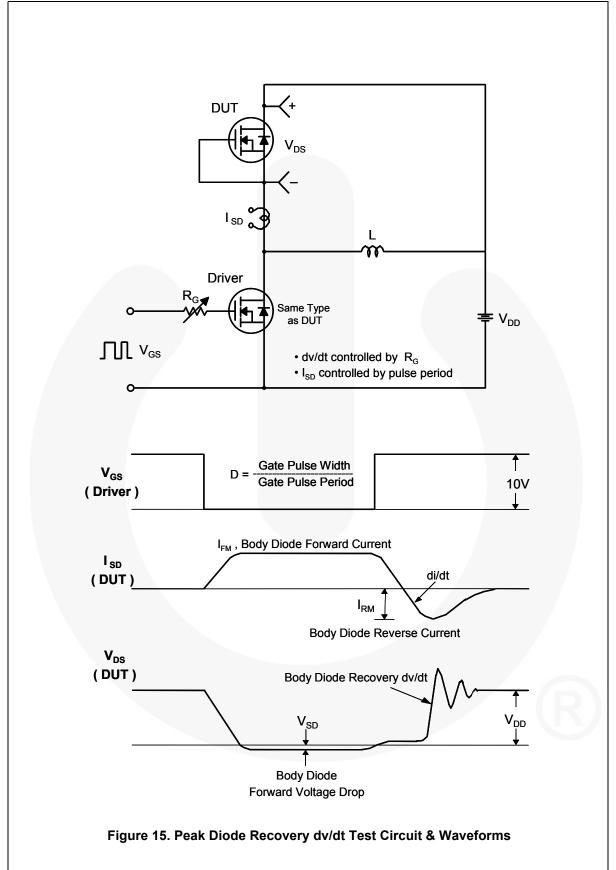
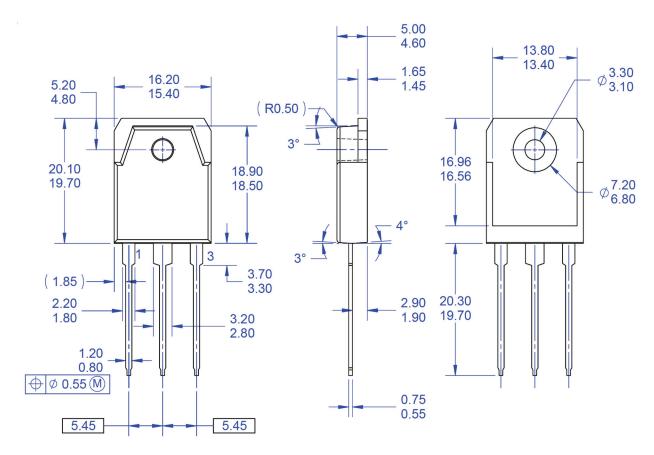
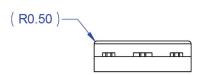


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Mechanical Dimensions





NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO EIAJ SC-65 PACKAGING STANDARD.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
 C) DIMENSION AND TOLERANCING PER
- ASME14.5-2009.
 D) DIMENSIONS ARE EXCLUSSIVE OF BURRS,
- MOLD FLASH, AND TIE BAR EXTRUSSIONS.

 E) DRAWING FILE NAME: TO3PN03AREV1.
- F) FAIRCHILD SEMICONDUCTOR.

Figure 16. TO3PN, 3-Lead, Plastic, EIAJ SC-65

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